HPI

TE Internal #: 1775469-2

PCB Mount Header, Right Angle, Wire-to-Board, 2 Position, .079 in [2 mm] Centerline, Fully Shrouded, Tin, Surface Mount, Signal,

Natural, HPI

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Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 2.0MM HEADERS











Connector System: Wire-to-Board

Number of Positions: 2

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]
PCB Mount Orientation: Right Angle

All AMP HPI 2.0MM HEADERS (212)

Features

Product Type Features

| Connector System | Wire-to-Board |
|-----------------------------------|-----------------------|
| Header Type | Fully Shrouded |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| PCB Connector Assembly Type | PCB Mount Header |
| Configuration Features | |
| Number of Positions | 2 |
| Number of Rows | 1 |
| PCB Mount Orientation | Right Angle |
| Electrical Characteristics | |
| Operating Voltage | 250 VAC |



| Drive on a Dro dust Color | Natural |
|---|------------------|
| Primary Product Color | Natural |
| Contact Features | |
| Contact Layout | Inline |
| Contact Mating Area Length | 3.53 mm[.139 in] |
| Mating Square Post Dimension | .5 mm[.02 in] |
| PCB Contact Termination Area Plating Material Thickness | 2 μm[80 μin] |
| Contact Mating Area Plating Material Thickness | 2 μm[80 μin] |
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Shape & Form | Square |
| Contact Mating Area Plating Material Finish | Matte |
| PCB Contact Termination Area Plating Material | Nickel |
| Contact Base Material | Brass |
| Contact Mating Area Plating Material | Tin |
| Contact Type | Pin |
| Contact Current Rating (Max) | 3 A |
| Termination Features | |
| Square Termination Post & Tail Dimension | .5 mm[.02 in] |
| Terminations per Post (Max) | 3 |
| Termination Post & Tail Length | 1 mm[.039 in] |
| Termination Method to Printed Circuit Board | Surface Mount |
| Mechanical Attachment | |
| Mating Alignment Type | Polarization |
| Mating Retention | Without |
| PCB Mount Retention Type | Solder Peg |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | With |
| Housing Features | |
| Housing Material | PA 9T GF |
| Centerline (Pitch) | 2 mm[.079 in] |
| Dimensions | |
| | |



| Connector Length | 7.4 mm[.291 in] |
|-----------------------------|---------------------------|
| Connector Height | 5.5 mm[.217 in] |
| Connector Width | 7.6 mm[.299 in] |
| Usage Conditions | |
| Operating Temperature Range | -25 – 85 °C[-13 – 185 °F] |
| Operation/Application | |
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Quantity | 600 |
| | |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Reflow solder capable to 260°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts



Also in the Series | HPI







Wire-to-Board Connector Assemblies & Housings(139)



Wire-to-Board Connector Contacts(2)

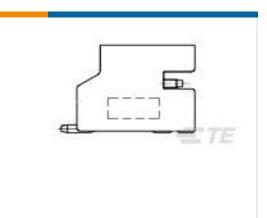
Customers Also Bought



TE Part #6609065-1 1EDP=F7687 S0



TE Part #440129-4
AMP HPI 2.0MM RECEPTACLE
HOUSINGS

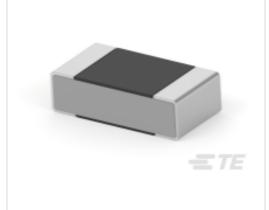


TE Part #1775469-3 HPI CONN., 2.0MM, R/A, SMT, 3P, 80U"





TE Part #1-1740196-2 15P HD20 REC.HEAD .EUROSTYLE SMT UNC4-40



TE Part #6-1879135-2 RN 0603 5R11 0.1% 10PPM 5K RL



TE Part #2-2176373-1 RQ 0805 16R2 0.1% 10PPM 1K RL TE Part #5532901-3 ASSY,RECPT,R.A.,HDI,LEAD-FREE,

Documents

CAD Files

Customer View Model ENG_CVM_CVM_1775469-2_A.2d_dxf.zip

English



3D PDF

3D

Customer View Model

ENG_CVM_CVM_1775469-2_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1775469-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

HPI Connectors QRG

English

Product Specifications

Application Specification

English

Product Environmental Compliance

MD_1775469-2_09262017322_dmtec

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Agency Approvals

UL Report

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